



Dimensions

Footprint	3528
L	3.5mm +/-0.2mm
W	2.8mm +/-0.2mm
H	1.9mm +/-0.2mm
S	0.7mm +/-0.3mm
F	2.2mm +/-0.1mm
K	1.4mm TYP

Packaging Specifications

Packaging	T&R, 330mm
Packaging Quantity	8000

General Information

Dielectric	MnO ₂ Tantalum
Style	SMD Chip
Description	SMD, Molded, Low ESR, Surge Robust
Features	Low ESR, Surge Robust
RoHS	Yes
Termination	Tin
AEC-Q200	No
Notes	Obsolete. Old Part Number [Obsolete] Was B45197A5225M206.

Specifications

Capacitance	2.2 uF
Capacitance Tolerance	20%
Voltage DC	25 VDC (85C), 16.75 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	4%
Failure Rate	N/A
ESR	1.2 Ohms (100kHz)
Ripple Current	270 mAmps (25C), 243 mAmps (85C), 108 mAmps (125C)
Leakage Current	0.6 uA